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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/866,068	05/24/2001	Chih-Chong Wang	60594-300401 6861		
7590 03/23/2005			EXAMINER		
PERKINS COIE, LLP			PATEL, NIHIR B		
101 JEFFERSON DRIVE MENLO PARK, CA 94025-1114			ART UNIT PAPER NUMBER  3743  DATE MAILED: 03/23/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

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## Advisory Action

Application No.	Applicant(s)
09/866,068	WANG ET AL.
Examiner	Art Unit
Nihir Patel	3743

Advisory Action	09/800,008	·					
Before the Filing of an Appeal Brief	Examiner	Art Unit					
	Nihir Patel	3743					
The MAILING DATE of this communication appe	pars on the cover sheet with the c	correspondence add	ress				
HE REPLY FILED 02.08.2005 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE.							
☐ The reply was filed after a final rejection, but prior to filing a Notice of Appeal. To avoid abandonment of this application,							
applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the							
application in condition for allowance; (2) a Notice of App	peal (with appeal fee) in compliance	e with 37 CFR 41.31;	or (3) a				
Request for Continued Examination (RCE) in compliance time periods:	with 37 OF No. 114. The reply mu	or ne men within one	or the following				
a) The periods.  The period for reply expiresmonths from the mailing date of the final rejection.							
b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no							
event, however, will the statutory period for reply expire later th	an SIX MONTHS from the mailing date o	i (ne tinal rejection. IRST DEDIVMAS EUF	D WITHIN TWO				
Examiner Note: If box 1 is checked, check either box (a) or (b) MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f	ን.						
Extensions of time may be obtained under 37 CFR 1.136(a). The date on seen filed is the date for purposes of determining the period of extension a	which the petition under 37 CFR 1.136(a	a) and the appropriate extension.  The appropriate extension	ension fee have on fee under 37				
CFR 1 17(a) is calculated from: (1) the expiration date of the shortened st	atutory period for reply originally set in the	final Office action; or (2)	as set forth in (b)				
above, if checked. Any reply received by the Office later than three month	is after the mailing date of the final rejection	on, even if timely filed, ma	ay reduce any				
earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL							
The reply was filed after the date of filing a Notice of App	peal, but prior to the date of filing a	n appeal brief. The N	otice of Appeal				
was filed on . A brief in compliance with 37 CFR 4	was filed on A brief in compliance with 37 CFR 41.37 must be filed within two months of the date of filing the Notice of						
Appeal (37 CFR 41.37(a)), or any extension thereof (37	CFR 41.37(e)), to avoid dismissal o	of the appeal. Since a	Notice of				
Appeal has been filed, any reply must be filed within the	ume period section in 37 CFR 41.	. στ (a).					
AMENDMENTS  3. The proposed amendment(s) filed after a final rejection.	, but prior to the date of filing a brie	ef, will not be entered	because				
(a) They raise new issues that would require further of	onsideration and/or search (see NC	TE below);					
(b) They raise the issue of new matter (see NOTE below	ow);						
(c) They are not deemed to place the application in be	etter form for appeal by materially re	educing or simplifying	g the issues for				
appeal; and/or (d)☐ They present additional claims without canceling a	corresponding number of finally re	ejected claims.					
NOTE: (See 37 CFR 1.116 and 41.33(a))	).						
4. The amendments are not in compliance with 37 CFR 1.	121. See attached Notice of Non-C	ompliant Amendmen	t (PTOL-324).				
5. Applicant's reply has overcome the following rejection(s	s):	Almosto Ellista					
<ol> <li>Newly proposed or amended claim(s) would be the non-allowable claim(s).</li> </ol>	allowable it submitted in a separate	e, timely filed amendr	nent canceling				
7. Tor purposes of appeal, the proposed amendment(s): a	) ☐ will not be entered, or b) ☐ v	vill be entered and an	explanation of				
how the new or amended claims would be rejected is pro-	ovided below or appended.						
The status of the claim(s) is (or will be) as follows:							
Claim(s) allowed: Claim(s) objected to:							
Claim(s) rejected:							
Claim(s) withdrawn from consideration:							
AFFIDAVIT OR OTHER EVIDENCE  8.  ☐ The affidavit or other evidence filed after a final action, because the control of the con	out before or on the date of filing a	Notice of Anneal will	not be entered				
because applicant failed to provide a showing of good a	nd sufficient reasons why the affida	avit or other evidence	is necessary				
and was not earlier presented. See 37 CFR 1.116(e).							
9. The affidavit or other evidence filed after the date of filin entered because the affidavit or other evidence failed to showing a good and sufficient reasons why it is necessar	overcome all rejections under appe	eal and/or appellant f	ails to provide a				
10. 🔲 The affidavit or other evidence is entered. An explanati	on of the status of the claims after	entry is below or atta	ched.				
REQUEST FOR RECONSIDERATION/OTHER  11.  The request for reconsideration has been considered be	out does NOT place the application	in condition for allow	ance because:				
see attached sheet.							
12. Note the attached Information Disclosure Statement(s). (PTO/SB/08 or PTO-1449) Paper No(s).							
13.							

In reference to claims 5, 8, 9, and 17 the applicant argues that Shimada never suggest or teaches to utilize the plate to surround the dies and the thermal pad for making the thermal pad closely compact to the die. The examiner disagrees. Shimada does suggest to utilize the plate 12 to surround the die and the thermal pad for making the thermal pad closely compact to the dies (see figure 3). The applicant also argues that Shimba never suggest or teaches that the right cooling fins of the heatsink are less than the left cooling fins of the heatsink. The examiner disagrees. As can be seen in figure 3, the right cooling fins of the heatsink are less (2 fins) than the left fins of the heatsink (3 fins).

Henry Bernett
Supervisory Patent Examiner